MOSFETs Silicon N-Channel MOS (DTMOS V)

TK290P60Y

1. Applications

- Switching Voltage Regulators

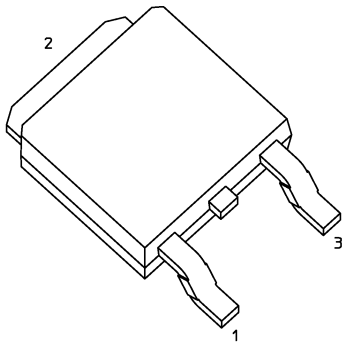
2. Features

(1) Low drain-source on-resistance: $R_{DS(ON)}$ = 0.23 Ω (typ.) by using Super Junction Structure : DTMOS

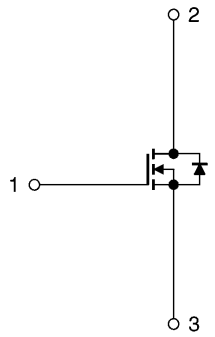
(2) Easy to control Gate switching

(3) Enhancement mode: V_{th} = 3 to 4 V (V_{DS} = 10 V, I_D = 0.45 mA)

3. Packaging and Internal Circuit



DPAK



1: Gate
2: Drain
3: Source

4. Absolute Maximum Ratings (Note) (T_a = 25 °C unless otherwise specified)

Characteristics			Symbol	Rating	Unit
Drain-source voltage			V_{DSS}	600	V
Gate-source voltage			V_{GSS}	±30	
Drain current (DC)	(T_c = 25 °C)	(Note 1)	I_D	11.5	A
Drain current (DC)	(T_c = 100 °C)	(Note 1)	I_D	7.3	A
Drain current (pulsed)	(T_c = 25 °C)	(Note 1)	I_{DP}	46	A
Power dissipation	(T_c = 25 °C)		P_D	100	W
Single-pulse avalanche energy		(Note 2)	E_{AS}	114	mJ
Single-pulse avalanche current			I_{AS}	3	A
Reverse drain current (DC)		(Note 1)	I_{DR}	11.5	
Reverse drain current (pulsed)		(Note 1)	I_{DRP}	46	A
Channel temperature			T_{ch}	150	°C
Storage temperature			T_{stg}	-55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Start of commercial production
2016-12

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5. Thermal Characteristics

Characteristics	Symbol	Max	Unit
Channel-to-case thermal resistance	$R_{th(ch-c)}$	1.25	°C/W
Channel-to-ambient thermal resistance	$R_{th(ch-a)}$	125	

Note 1: Ensure that the channel temperature does not exceed 150 °C.
Note 2: V_{DD} = 90 V, T_{ch} = 25 °C (initial), L = 22.3 mH, R_G = 25 Ω, I_{AS} = 3 A

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

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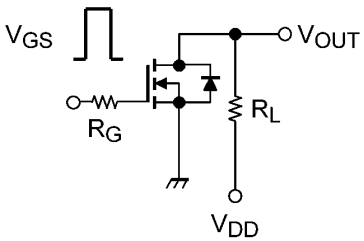
6. Electrical Characteristics

6.1. Static Characteristics (T_a = 25 °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	I_{GSS}	V_{GS} = ±30 V, V_{DS} = 0 V	—	—	±1	μA
Drain cut-off current	I_{DSS}	V_{DS} = 600 V, V_{GS} = 0 V	—	—	10	
Drain-source breakdown voltage	$V_{(BR)DSS}$	I_D = 10 mA, V_{GS} = 0 V	600	—	—	V
Gate threshold voltage	V_{th}	V_{DS} = 10 V, I_D = 0.45 mA	3	—	4	
Drain-source on-resistance	$R_{DS(ON)}$	V_{GS} = 10 V, I_D = 5.8 A	—	0.23	0.29	Ω

6.2. Dynamic Characteristics (T_a = 25 °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Input capacitance	C_{iss}	V_{DS} = 300 V, V_{GS} = 0 V, f = 100 kHz	—	730	—	pF
Reverse transfer capacitance	C_{rss}		—	2.5	—	
Output capacitance	C_{oss}		—	26	—	
Effective output capacitance	$C_{o(er)}$	V_{DS} = 0 to 400 V, V_{GS} = 0 V	—	48	—	
Gate resistance	r_g	V_{DS} = OPEN , f = 1 MHz	—	32	—	Ω
Switching time (rise time)	t_r	See Figure 6.2.1	—	25	—	ns
Switching time (turn-on time)	t_{on}		—	65	—	
Switching time (fall time)	t_f		—	8.5	—	
Switching time (turn-off time)	t_{off}		—	170	—	
MOSFET dv/dt ruggedness	dv/dt	$V_{DS} \leq V_{(BR)DSS}$, $I_D \leq$ 5.8 A	50	—	—	V/ns



$V_{DD} \approx$ 400 V
V_{GS} = 10 V/0 V
I_D = 5.8 A
R_L = 68 Ω
R_G = 10 Ω
Duty ≤ 1 %, t_w = 10 μs

Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics (T_a = 25 °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Q_g	$V_{DD} \approx$ 400 V, V_{GS} = 10 V, I_D = 11.5 A	—	25	—	nC
Gate-source charge 1	Q_{gs1}		—	4	—	
Gate-drain charge	Q_{gd}		—	13	—	

6.4. Source-Drain Characteristics (T_a = 25 °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Diode forward voltage	V_{DSF}	I_{DR} = 11.5 A, V_{GS} = 0 V	—	—	-1.7	V
Reverse recovery time	t_{rr}	$V_{DD} \approx$ 400 V I_{DR} = 5.8 A, V_{GS} = 0 V $-dI_{DR}/dt$ = 100 A/μs	—	240	—	ns
Reverse recovery charge	Q_{rr}		—	2.3	—	μC
Peak reverse recovery current	I_{rr}		—	20	—	A
Diode dv/dt ruggedness	dv/dt	$V_{DS} \leq$ 400 V, $I_{DR} \leq$ 5.8 A, V_{GS} = 0 V	15	—	—	V/ns

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7. Marking

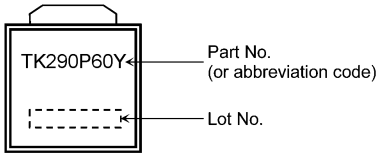

Fig. 7.1 Marking

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8. Characteristics Curves (Note)

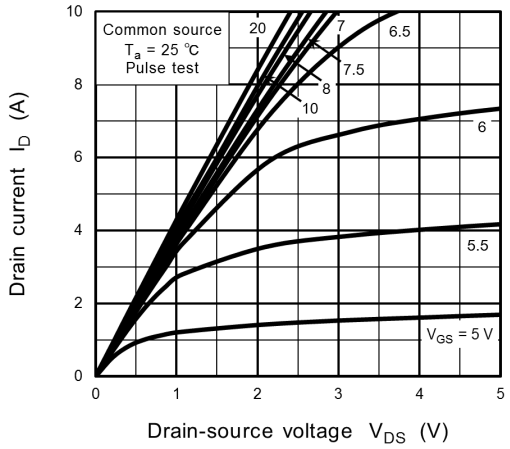

Fig. 8.1 I_D - V_{DS}

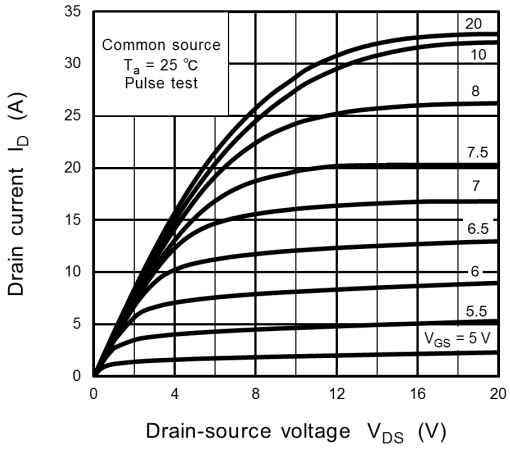

Fig. 8.2 I_D - V_{DS}

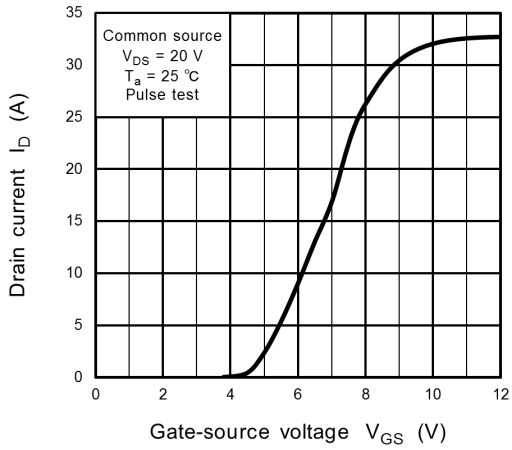

Fig. 8.3 I_D - V_{GS}

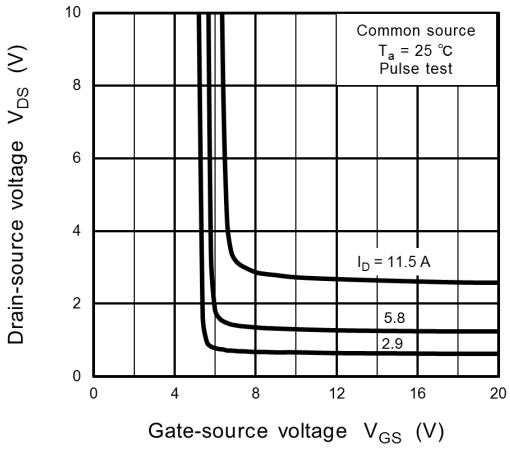

Fig. 8.4 V_{DS} - V_{GS}

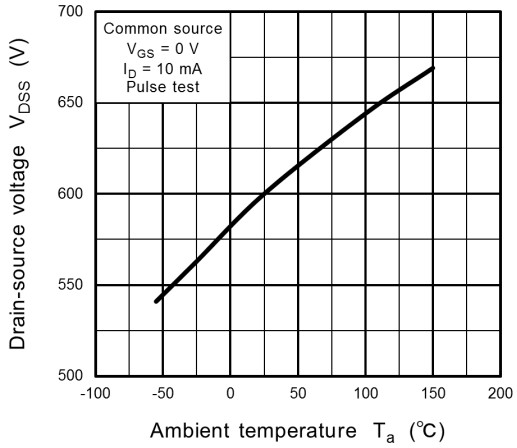

Fig. 8.5 V_{DSS} - T_a

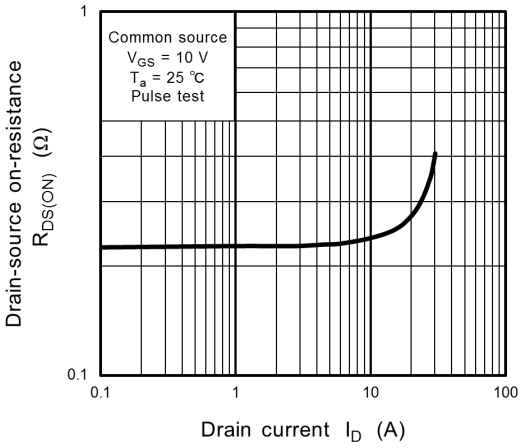

Fig. 8.6 $R_{DS(ON)}$ - I_D

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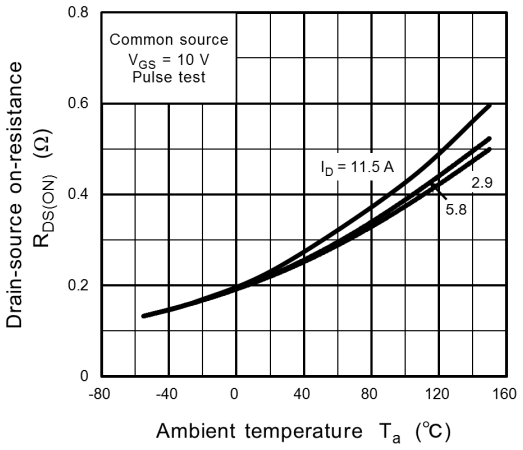

Fig. 8.7 $R_{DS(ON)}$ - T_a

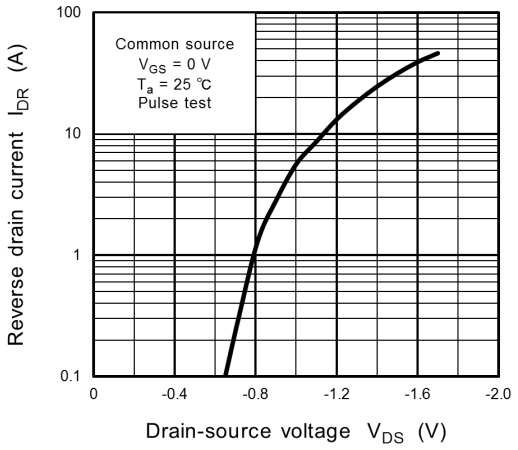

Fig. 8.8 I_{DR} - V_{DS}

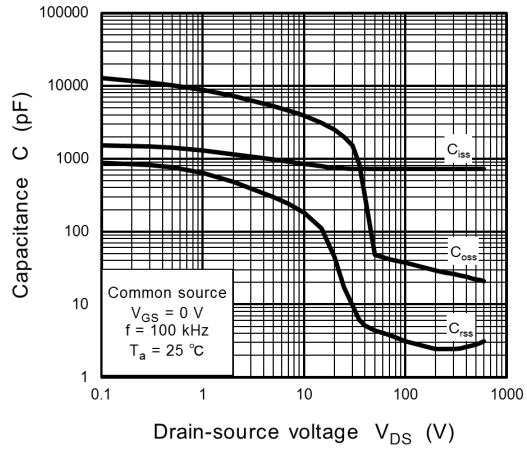

Fig. 8.9 C - V_{DS}

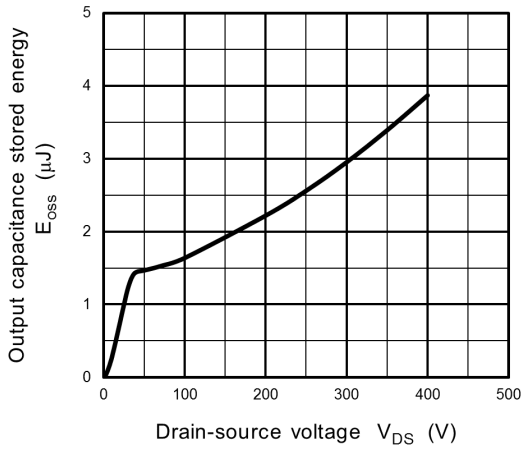

Fig. 8.10 E_{oss} - V_{DS}

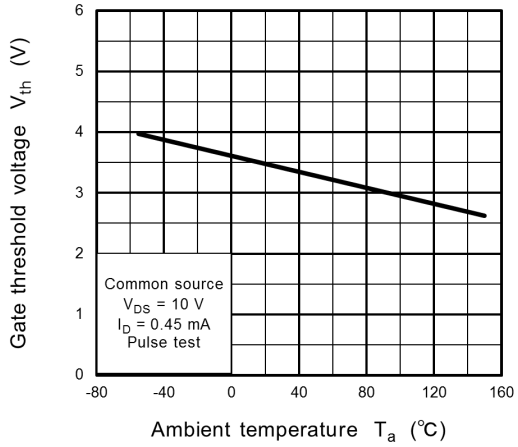

Fig. 8.11 V_{th} - T_a

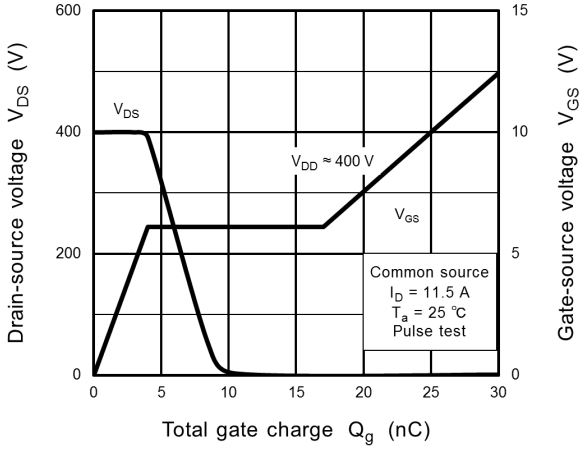

Fig. 8.12 Dynamic Input/Output Characteristics

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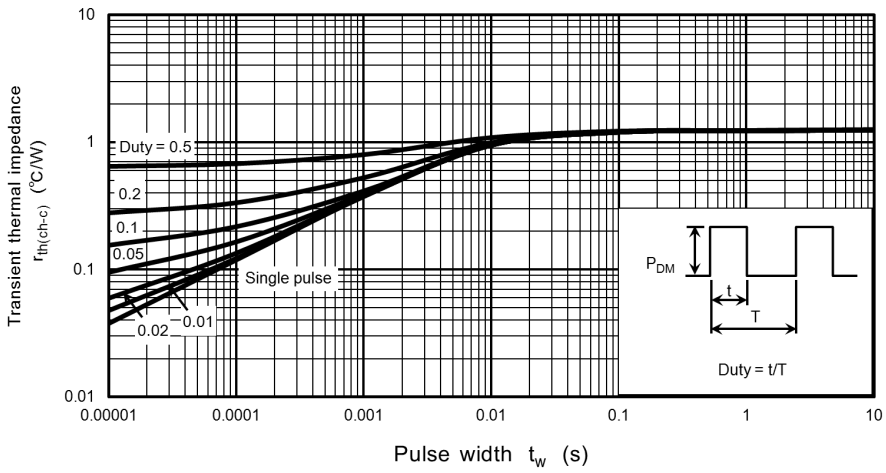


Fig. 8.13 r_{th} - t_w
(Guaranteed Maximum)

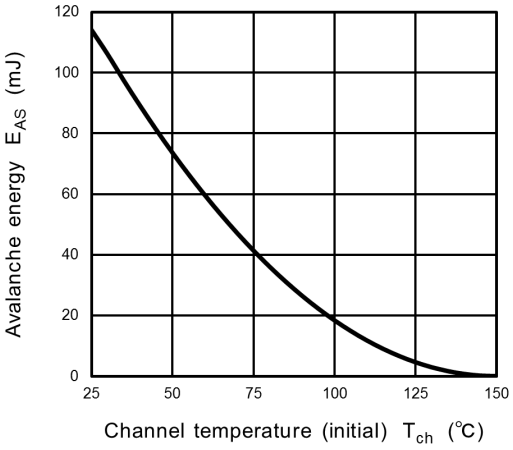


Fig. 8.14 E_{AS} - T_{ch}
(Guaranteed Maximum)

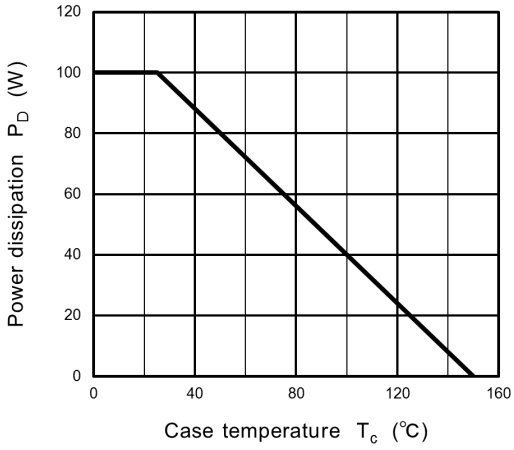
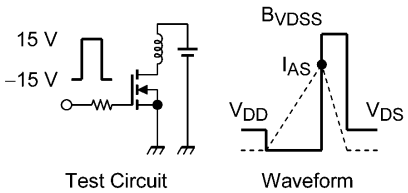


Fig. 8.15 P_D - T_c
(Guaranteed Maximum)



$R_G = 25\ \Omega$, $V_{DD} = 90$ V $E_{AS} = \frac{1}{2} \cdot L \cdot I_{AS}^2 \cdot \left(\frac{B_{VDSS}}{B_{VDSS} - V_{DD}}\right)$

Fig. 8.16 Test Circuit/Waveform

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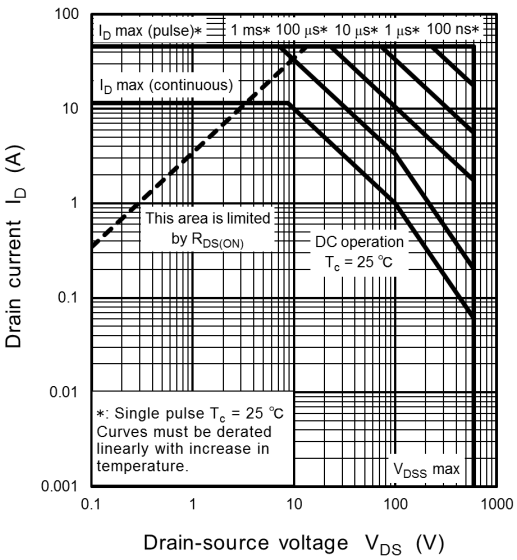

Fig. 8.17 Safe Operating Area (Guaranteed Maximum)

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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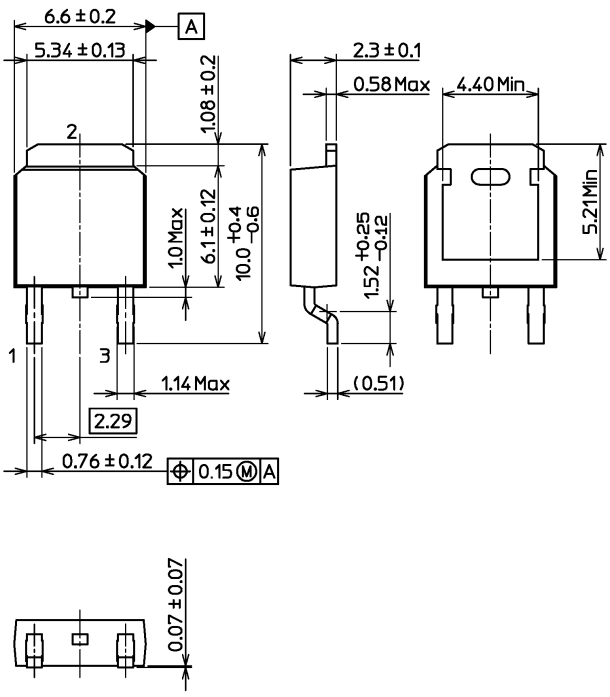
Package Dimensions

Unit: mm



Weight: 0.36 g (typ.)

Package Name(s)
TOSHIBA: 2-7K1S
Nickname: DPAK

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